



JT010N065SED/CED/FED/WED

主要参数 MAIN CHARACTERISTICS

I_C	10 A
BV_{CES}	650V
$V_{CESAT-typ}$ ($V_{GE}=15V$)	1.5V

用途

- 逆变器
- UPS 电源
- 电机控制

产品特性

- 低栅极电荷
- Trench FS 技术,
- RoHS 产品

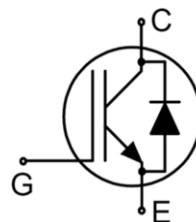
APPLICATIONS

- General purpose inverters
- UPS
- Motor Control

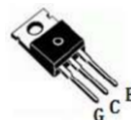
FEATURES

- Low gate charge
- Trench FS Technology,
- RoHS product

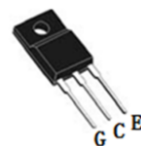
封装 Package



TO-263



TO-220C



TO-220MF



TO-247

订 货 型 号 Order codes				印 记 Marking	封 装 Package
有卤-条管 Halogen-Tube	无卤-条管 None Halogen-Tube	有卤-编带 Halogen-Reel	无卤-编带 Halogen-Free-Reel		
JT010N065SED-S-B	JT010N065SED-S-BR	JT010N065SED-S-A	JT010N065SED-S-AR	JT010N065SED	TO-263
JT010N065CED-C-B	JT010N065CED-C-BR	N/A	N/A	JT010N065CED	TO-220C
JT010N065FED-F-B	JT010N065FED-F-BR	N/A	N/A	JT010N065FED	TO-220MF
JT010N065WED-GE-B	JT010N065WED-GE-BR	N/A	N/A	JT010N065WED	TO-247



绝对最大额定值 ABSOLUTE RATINGS ($T_c=25^{\circ}\text{C}$)

项 目 Parameter	符 号 Symbol	数 值 Value			单 位 Unit
		JT010N065SED/ JT010N065CED	JT010N065FED	JT010N065WED	
最高集电极—发射极直流电压 Collector-Emmitter Voltage	V_{CES}	650	650	650	V
*连续集电极电流 Collector Current-continuous	I_C	20 ($T_c=25^{\circ}\text{C}$)	20 ($T_c=25^{\circ}\text{C}$)	20 ($T_c=25^{\circ}\text{C}$)	A
		10 ($T_c=100^{\circ}\text{C}$)	10 ($T_c=100^{\circ}\text{C}$)	10 ($T_c=100^{\circ}\text{C}$)	A
最大脉冲集电极极电流 (注1) Collector Current – pulse (note 1)	I_{CM}	40	40	40	A
二极管正向测试电流 Diode RMS forward current	I_F	20($T_c=25^{\circ}\text{C}$)	20($T_c=25^{\circ}\text{C}$)	20($T_c=25^{\circ}\text{C}$)	A
	I_F	10($T_c=100^{\circ}\text{C}$)	10($T_c=100^{\circ}\text{C}$)	10($T_c=100^{\circ}\text{C}$)	A
二极管正向不重复峰值电流 (浪涌电流) Surge non repetitive forward current $t_p=10\text{ ms}$ sinusoidal	I_{FSM}	40	40	40	A
最高栅极发射极电压 Gate-Emmitter Voltage	V_{GES}	± 30	± 30	± 30	V
Turn-off safe area	-	40	40	40	A
耗散功率 Power Dissipation	P_D $T_c=25^{\circ}\text{C}$	136	37	166	W
存储温度 Storage Temperature Range	T_{STG}	$-55\sim+150$	$-55\sim+150$	$-55\sim+150$	$^{\circ}\text{C}$
结温 Junction Temperature Range	T_J	$-55\sim+175$	$-55\sim+175$	$-55\sim+175$	$^{\circ}\text{C}$
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T_L	300	300	300	$^{\circ}\text{C}$

*连续集电极电流由最高结温限制。*Collector current limited by maximum Junction temperature.

注 1: 脉冲宽度由最高结温限制。Note1: The pulse width is limited by the maximum junction temperature.





电特性 ELECTRICAL CHARACTERISTICS

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
关态特性 Off –Characteristics						
集电极—发射极击穿电压 Collector-Emmitter Voltage	BV _{CES}	I _C =500μA, V _{GE} =0V	650	-	-	V
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	ΔBV _{CES} /ΔT _J	I _C =1mA, referenced to 25°C	-	0.5	-	V/°C
零栅压下集电极漏电流 Zero Gate Voltage Collector Current	I _{CES}	V _{CE} =650V, V _{GE} =0V, T _C =25°C	-	-	10	μ A
		V _{CE} =650V, V _{GE} =0V, T _C =175°C			2	mA
正向栅极体漏电流 Gate-body leakage current, forward	I _{GESF}	V _{CE} =0V, V _{GE} =20V	-	-	200	nA
反向栅极体漏电流 Gate-body leakage current, reverse	I _{GESR}	V _{CE} =0V, V _{GE} =-20V	-	-	-200	nA
通态特性 On-Characteristics						
阈值电压 Gate Threshold Voltage	V _{GE(th)}	V _{CE} =V _{GE} , I _C =250Ua T _c =25°C	5.5	6	6.5	V
饱和压降 Collector-Emmitter saturation Voltage	V _{CESAT}	V _{GE} =15V, I _C =10A, T _c =25°C	-	1.5	1.9	V
		V _{GE} =15V, I _C =10A, T _c =125°C	-	1.65	2.05	V
		V _{GE} =15V, I _C =10A, T _c =175°C	-	1.8	2.2	V
动态特性 Dynamic Characteristics						
输入电容 Input capacitance	C _{ies}	V _{CE} =25V, V _{GE} =0V, f=1.0MHz, T _C =25°C	-	800	-	pF
输出电容 Output capacitance	C _{oes}		-	60	-	pF
反向传输电容 Reverse transfer capacitance	C _{res}		-	17	-	pF
栅极电荷总量 Total Gate Charge	Q _g	V _{CC} =400V, I _C =10A, R _G =10Ω, V _{GE} =15V, T _C =25°C	-	27.4	-	nC
栅极-发射极 Gate to emitter charge	Q _{ge}		-	6.5	-	
栅极-集电极 Gate to collector charge	Q _{gc}		-	11.9	-	
栅极电阻-Gate resistance	R _g	f=1MHz, open collector	-	2.1	-	Ω
短路电流-short current	I _{sc}	V _{GE} =15V, V _{CE} =360V, T _{Jstart} ≤175°C, t≤10μs	-	58	-	A





电特性 ELECTRICAL CHARACTERISTICS

开关特性 Switching Characteristics						
项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
开启延迟时间 Turn-On delay time	t _{d(on)}	V _{CC} =400V,I _{CC} =10A, R _G =10Ω, V _{GE} =15V, T _C =25°C	-	13	-	ns
上升时间 Turn-On rise time	t _r		-	20	-	ns
关断延迟时间 Turn-Off delay time	t _{d(off)}		-	47	-	ns
下降时间 Turn-Off Fall time	t _f		-	60	-	ns
开通损耗 Turn-On energy	E _{on}		-	0.35	-	mJ
关断损耗 Turn-off energy	E _{off}		-	0.1	-	mJ
总开关损耗 Total switching energy	E _{tot}		-	0.45	-	mJ
开启延迟时间 Turn-On delay time	t _{d(on)}	V _{CC} =400V,I _C =10A, R _G =10Ω,V _{GE} =15V, T _C =175°C	-	16.0	-	ns
上升时间 Turn-On rise time	t _r		-	20.0	-	ns
关断延迟时间 Turn-Off delay time	t _{d(off)}		-	68.0	-	ns
下降时间 Turn-Off Fall time	t _f		-	84.0	-	ns
开通损耗 Turn-On energy	E _{on}		-	0.35	-	mJ
关断损耗 Turn-off energy	E _{off}		-	0.17	-	mJ
总开关损耗 Total switching energy	E _{tot}		-	0.52	-	mJ
反并联二极管特性及最大额定值 Anti-Parallel Diode Characteristics and Maximum Ratings						
正向压降 Drain-Source Diode Forward Voltage	V _F	V _{GE} =0V, I _F =10A,T _C =25°C	-	1.75	-	V
		V _{GE} =0V, I _F =10A,T _C =125°C	-	1.45	-	V
		V _{GE} =0V, I _F =10A,T _C =175°C	-	1.25	-	V
反向恢复时间 Diode Reverse recovery time	t _{rr}	T _C =25°C,I _F =10A, V _{GE} =0V,d _i /d _t =100A/us	-	54.6	-	ns
反向恢复电荷 Diode Reverse recovery charge	Q _{rr}		-	34.9	-	nC
反向恢复电流 Diode Reverse recovery Current	I _{rrm}		-	1.13	-	A
反向恢复时间 Diode Reverse recovery time	t _{rr}	T _C =175°C, I _F =10A, V _{GE} =0V,d _i /d _t =100A/us	-	80.9	-	ns
反向恢复电荷 Diode Reverse recovery charge	Q _{rr}		-	51.7	-	nC
反向恢复电流 Diode Reverse recovery Current	I _{rrm}		-	1.67	-	A





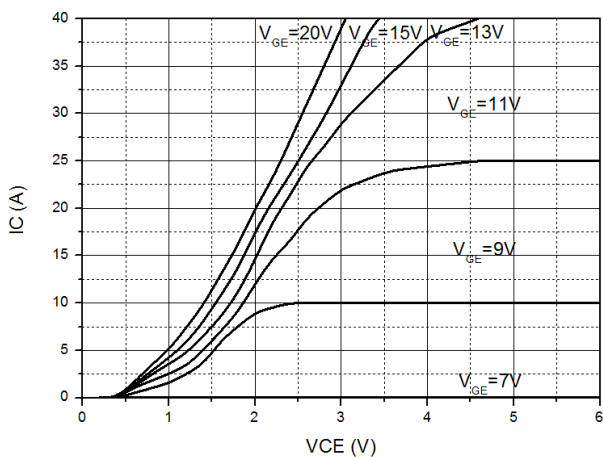
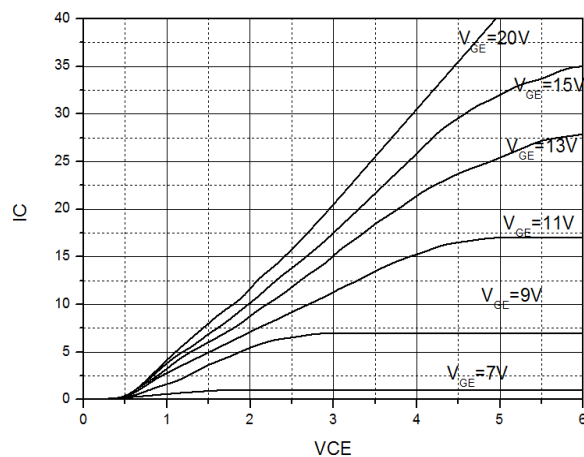
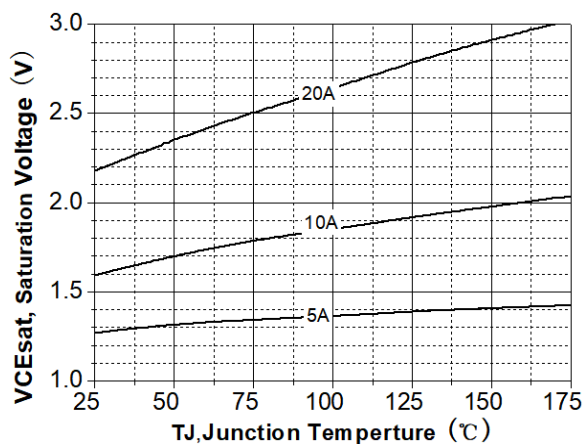
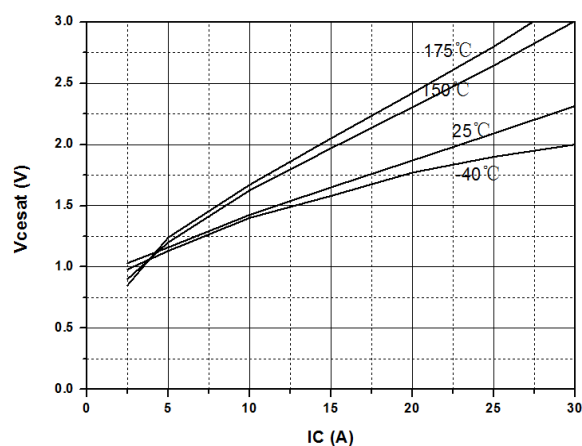
JT010N065SED CED FED WED

项目 Parameter	符号 Symbol	最大 (max)			单位 Unit
		JT010N065SED/ JT010N065CED	JT010N065FED	JT010N065WED	
结到管壳的热阻 (IGBT) Thermal Resistance, Junction to Case	$R_{th(J-C)}$	1.1	3.1	0.9	°C/W
结到管壳的热阻 (FRD) Thermal Resistance, Junction to Case	$R_{th(J-C)}$	2.2	4.9	2.1	°C/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	$R_{th(J-A)}$	62.5	62.5	40	°C/W

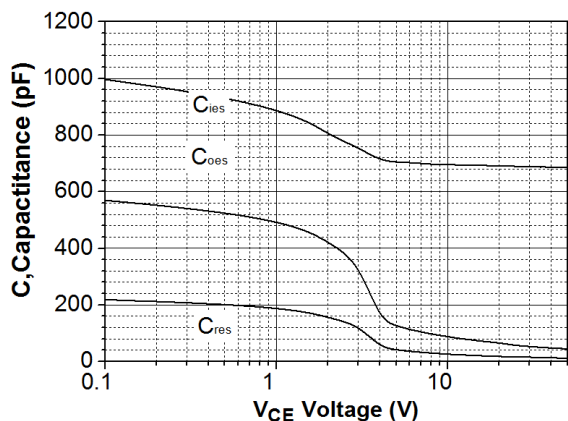




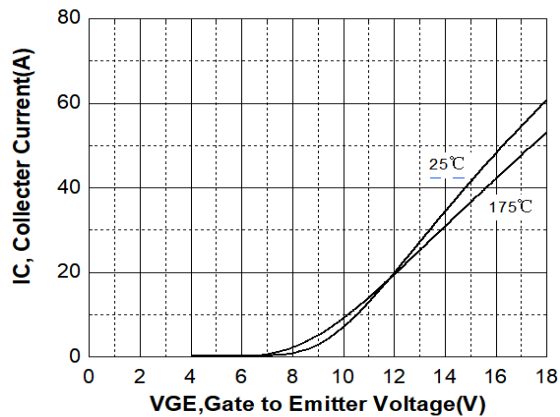
特征曲线 ELECTRICAL CHARACTERISTICS (curves)

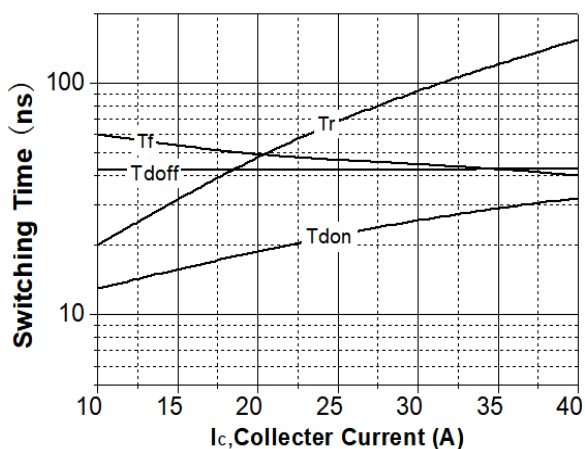
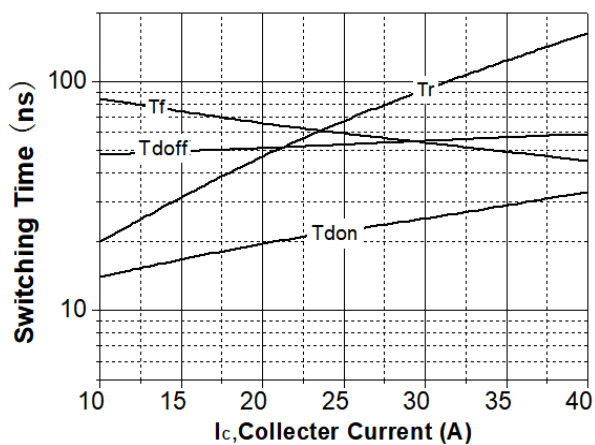
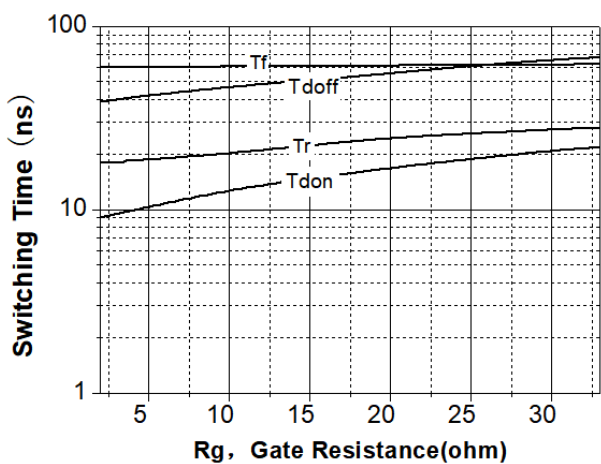
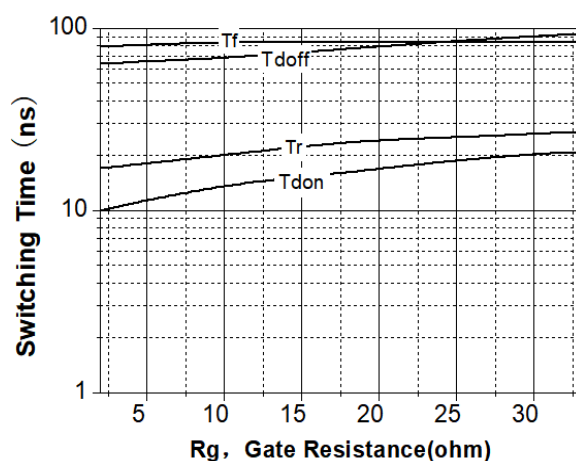
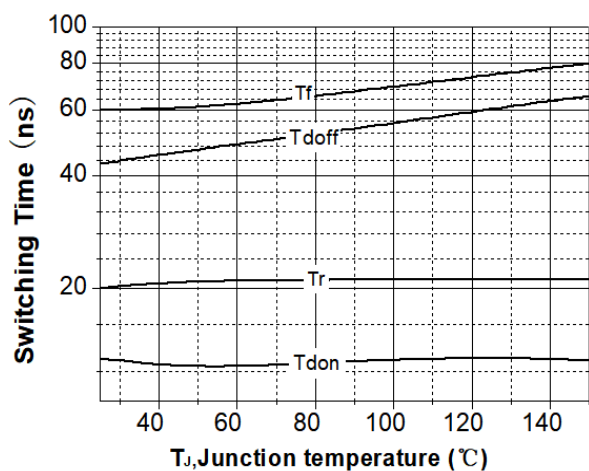
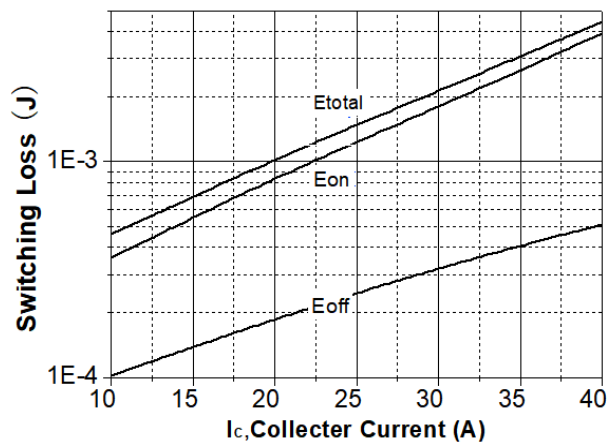
Output Characteristics $T_J=25^\circ\text{C}$ Output Characteristics $T_J=175^\circ\text{C}$  V_{CESAT} vs T_J  V_{CESAT} vs I_C 

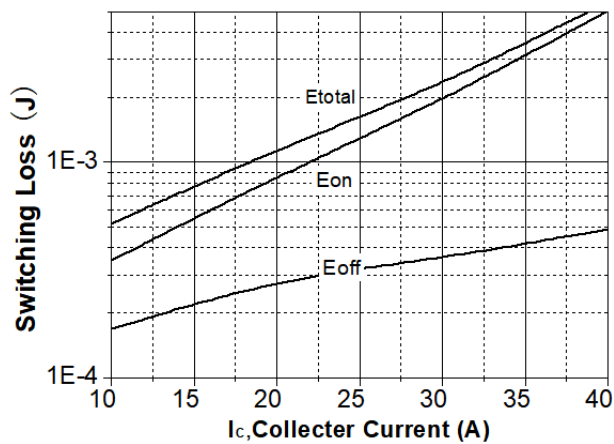
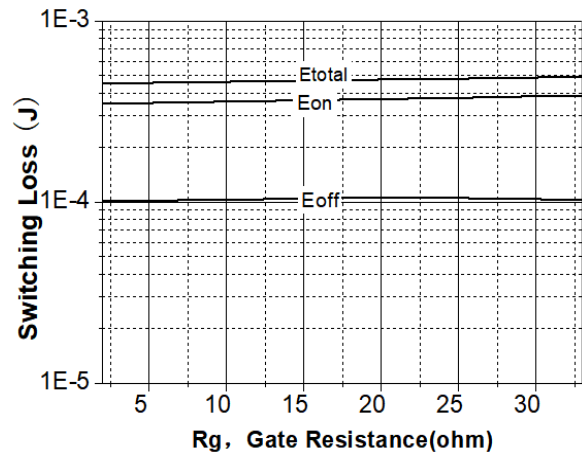
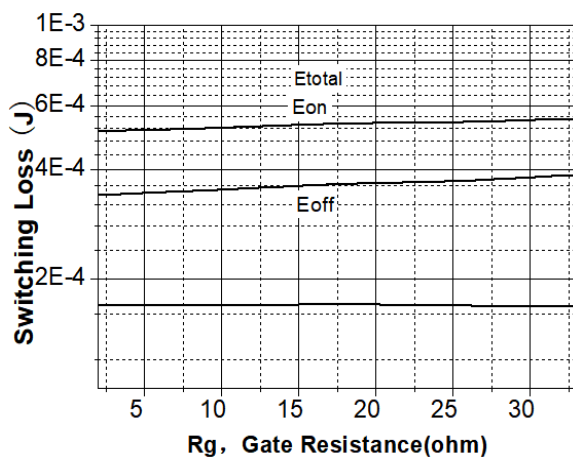
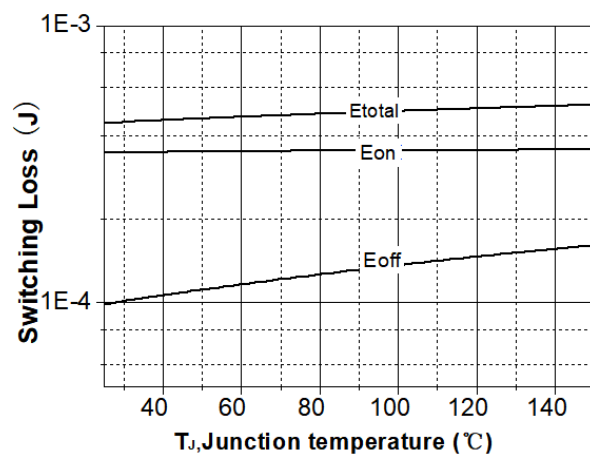
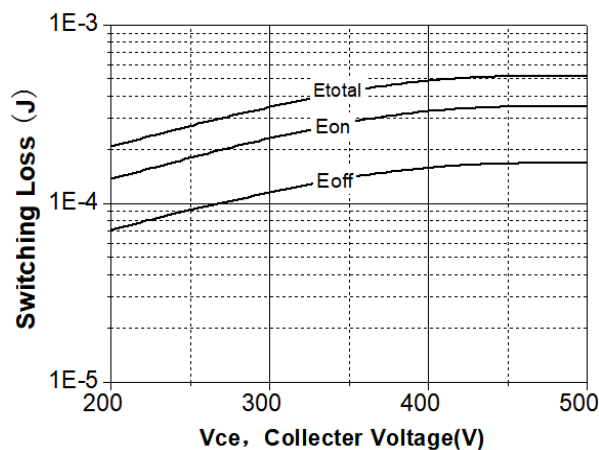
Capacitance Characteristic

 $V_{GE}=0V, f=1.0\text{MHz}$ 

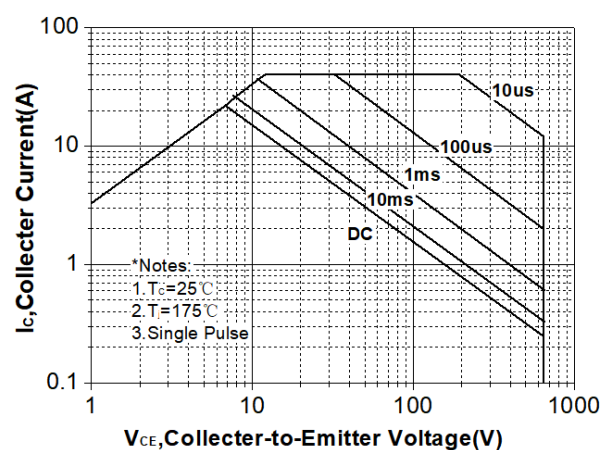
Transfer Characteristics



SwitchingTime vs. I_C $T_J=25^{\circ}\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, R_g=10\Omega$ SwitchingTime vs. I_C $T_J=175^{\circ}\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, R_g=10\Omega$ SwitchingTime vs. R_g $T_J=25^{\circ}\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=10\text{A}$ SwitchingTime vs. R_g $T_J=175^{\circ}\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=10\text{A}$ Switching Time vs. T_J Switching Loss vs. I_C $T_J=25^{\circ}\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, R_g=10\Omega$ 

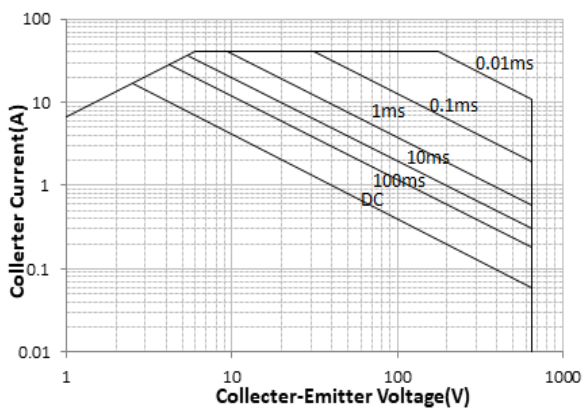
Switching Loss vs. I_C $T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, R_g=10\Omega$ Switching Loss vs. I_C $T_J=25^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=10\text{A}$ Switching Loss vs. R_g $T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=10\text{A}$ Switching Loss vs. T_J $V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=10\text{A}, R_g=10\Omega$ Switching Loss vs. $V_{CE}(V)$ $T_J=175^\circ\text{C}, V_{GE}=15\text{V}, I_C=10\text{A}, R_g=10\Omega$ 

Safe Operating Area TO-263/TO-220C

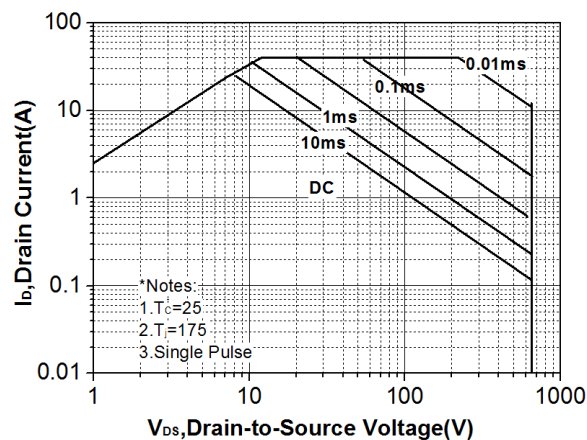
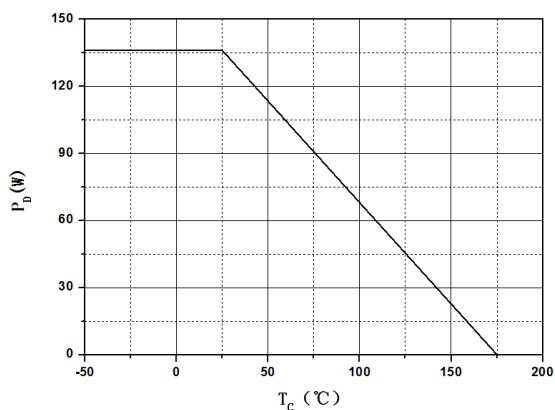
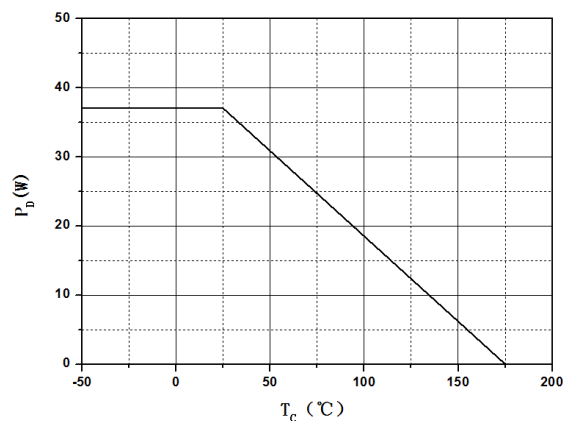
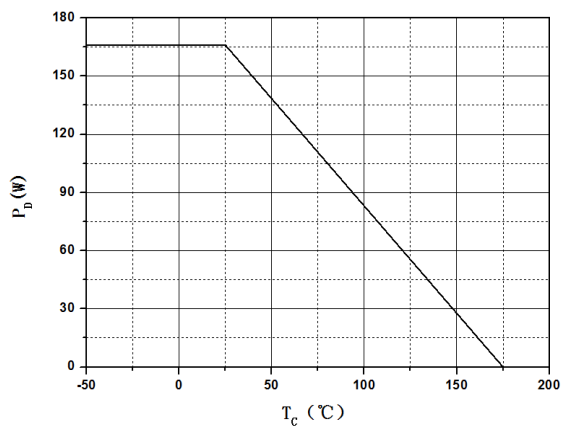
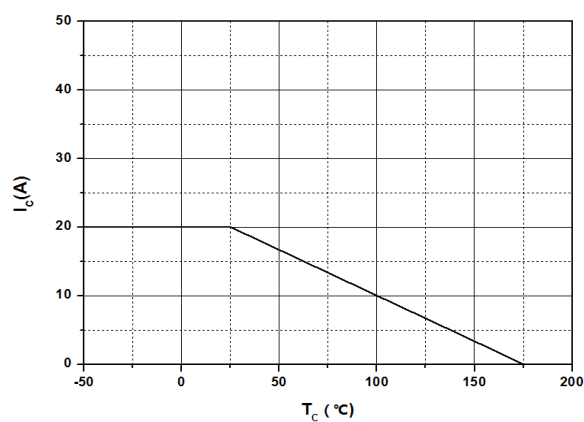




Safe Operating Area TO-220MF

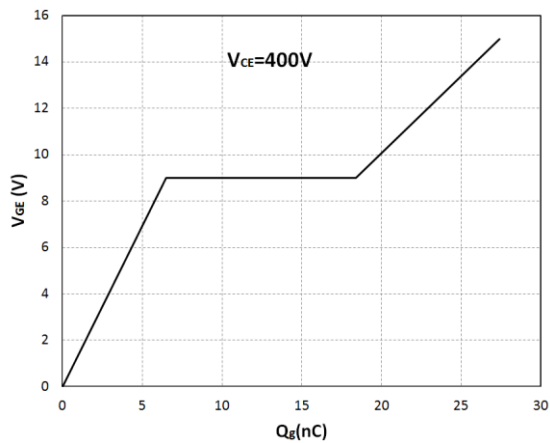


Safe Operating Area TO-247

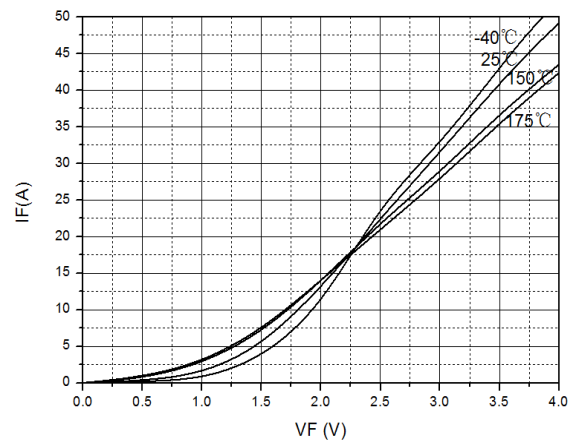
 P_D VS temperature (TO-263/TO-220C) P_D VS temperature (TO-220MF) P_D VS temperature (TO-247) I_C VS temperature



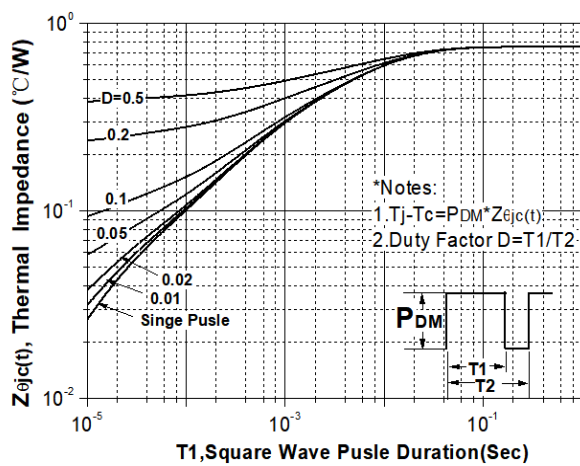
Q_g VS V_{GE}



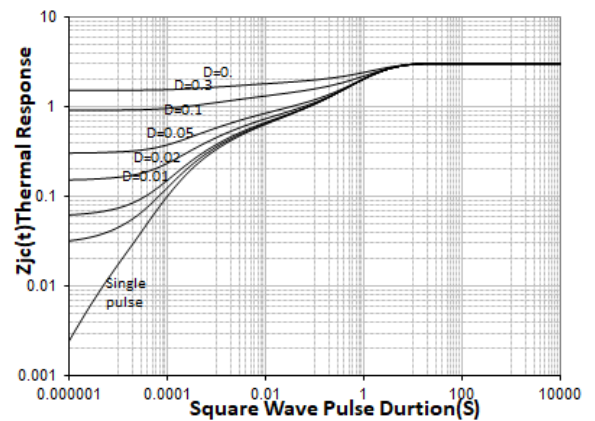
Diode Characteristic



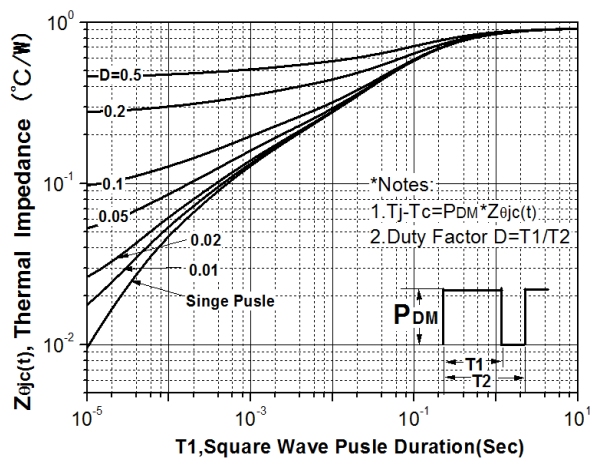
Normalized Maximum Transient Thermal Impedance for IGBT(TO-263/TO-220C)



Normalized Maximum Transient Thermal Impedance for IGBT(TO-220MF)



Normalized Maximum Transient Thermal Impedance for IGBT(TO-247)

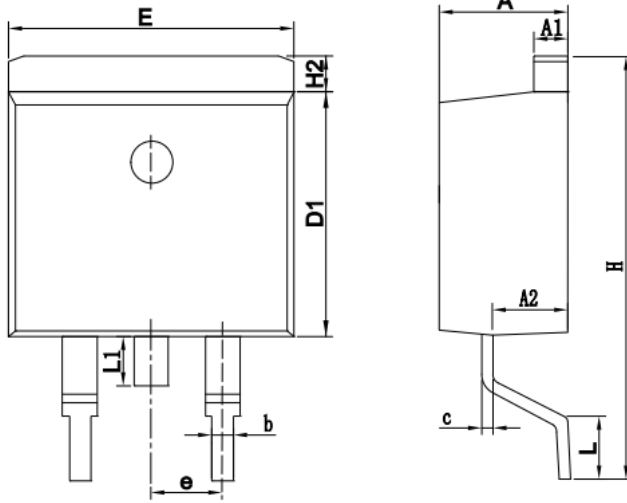




外形尺寸PACKAGE MECHANICAL DATA

TO-263

单位 UNIT:mm



SYMBOL	MIN	MAX
A	4.30	4.80
A1	1.12	1.42
A2	2.54	2.84
b	0.67	1.00
c	0.29	0.52
D1	8.40	9.00
E	9.80	10.46
e	2.54 BSC	
H	14.50	15.50
H2	1.12	1.45
L	1.50	2.80
L1	1.45	1.70

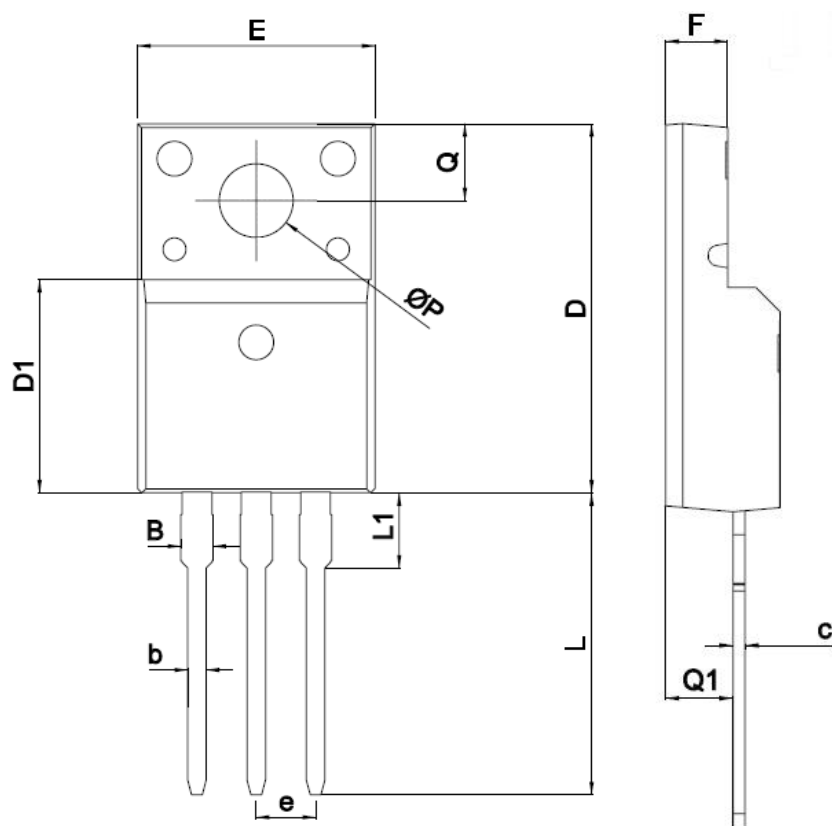




外形尺寸PACKAGE MECHANICAL DATA

TO-220MF

单位 UNIT:mm



SYMBOL	mm	
	MIN	MAX
A	4.5	4.9
B		1.47
b	0.7	0.9
c	0.45	0.60
D	15.67	16.07
D1	9.04	9.20
e	2.54TYPE	
E	9.96	10.36
F	2.34	2.74
L	12.58	13.38
L1	3.13	3.33
Q	3.2	3.4
Q1	2.56	2.96
ΦP	3.08	3.28

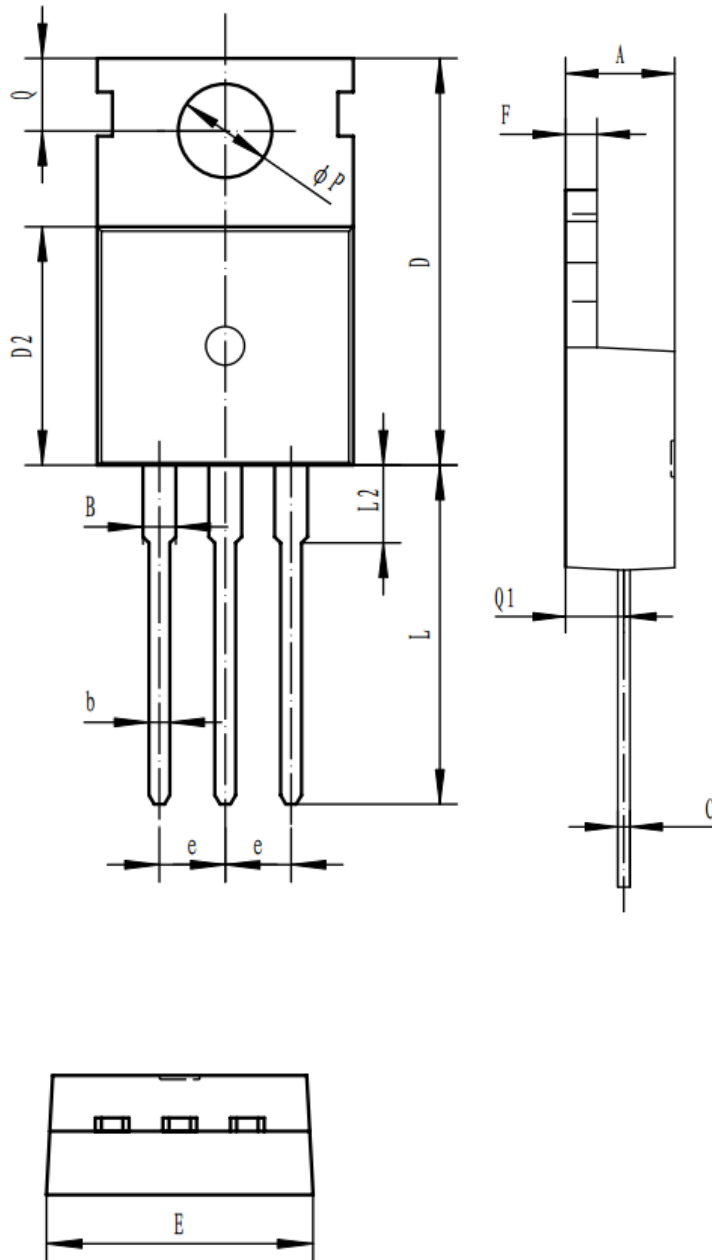




外形尺寸PACKAGE MECHANICAL DATA

TO-220C

单位 UNIT:mm



符号 symbol	MIN	MAX
A	4.30	4.70
B	1.22	1.40
b	0.70	0.95
c	0.40	0.65
D	15.20	16.20
D2	9.00	9.40
E	9.70	10.10
e	2.39	2.69
F	1.25	1.40
L	12.60	13.60
L2	2.80	3.20
Q	2.60	3.00
Q1	2.20	2.60
P	3.50	3.80

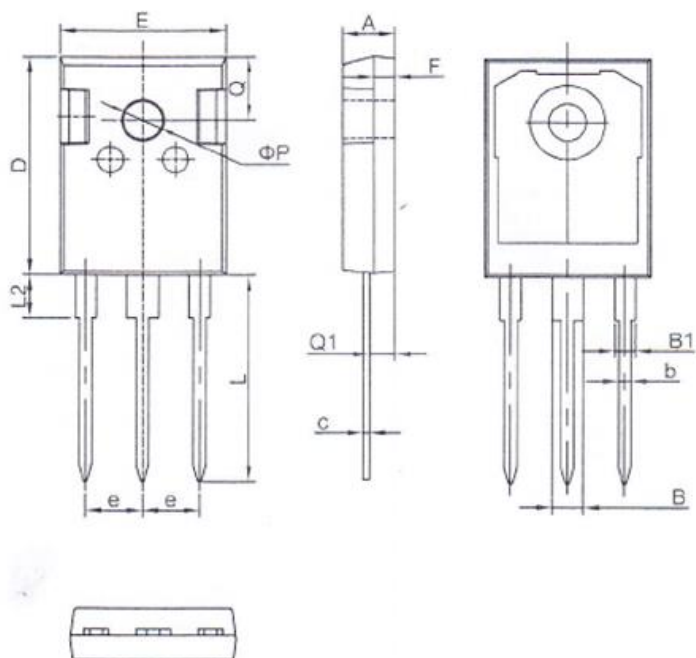




外形尺寸PACKAGE MECHANICAL DATA

TO-247

单位 UNIT:mm



符号 symbol	MIN	MAX
A	4.90	5.10
B	2.95	3.35
B1	1.95	2.35
b	1.15	1.35
c	0.50	0.70
D	20.90	21.10
E	15.70	15.90
e	5.34	5.54
F	1.90	2.10
L	19.40	20.40
L2	4.03	4.23
Q	6.00	6.40
Q1	2.30	2.50
P	3.50	3.70





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NOTE

1. Jilin Sino-microelectronics co., Ltd sales its product either through direct sales or sales agent , thus, for customers, when ordering , please check with our company.
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